

DESCRIPTION

Method for Fining a Metal Surface and a Metal Product Produced Thereby

Technical Field

This invention relates to a method for fining a surface of a metal product to form crystal grains having sizes less than $1 \mu\text{m}$ at its surface and for producing a metal product thereby.

Background of the Invention

It is well known that when a surface of a metal product has been projected upon by shot peening, the micro-structure of the surface can be fined. (See Literature 1.) Literature 1 discloses that a micro-structure having fine grain sizes in a surface layer with a high dislocation density that is formed by shot peening is useful to improve the fatigue characteristics of a metal product.

Literature 1: A. Niku-Lari, First International Conference on Shot Peening, United Kingdom, Pergamon Press, 1981, p. 192.

Disclosures of Invention

However, Literature 1 does not disclose forming crystal grains having sizes of less than $1 \mu\text{m}$. Namely, it does not disclose mechanisms and conditions to form crystal grains having sizes of less than $1 \mu\text{m}$.

This invention is directed to solve this problem. Namely, the purpose of this invention is to provide a method for fining a surface of a metal product to form crystal grains having sizes of less than $1 \mu\text{m}$ at its surface.

Further, the purpose of this invention is to provide a metal product that is treated by the method.

To achieve the purpose, the method according to this invention is comprised of a process for forming crystal grains having sizes of less than $1 \mu\text{m}$ at the surface of the metal product by projecting or peening shots or

projectiles while the power per unit of area of the surface is controlled at a predetermined value.

According to this invention, it is possible to improve fatigue strength, hardness, and a corrosion resistance of a metal product by forming crystal grains having sizes of less than $1\ \mu\text{m}$ at the surface of the metal product.

As explained above, this invention is comprised of a method for forming crystal grains having sizes of less than $1\ \mu\text{m}$ at the surface of the metal product by projecting or peening shots or projectiles while the power per unit of area of the surface, which power is caused by projecting or peening shots or projectiles, is controlled at a predetermined value. The metal product is treated by this method. Thus, according to this invention, the fatigue strength, the hardness, and the corrosion resistance of the metal product can be improved by forming crystal grains having sizes of less than $1\ \mu\text{m}$ at the surface of the metal product.

Brief Descriptions of the Drawings

Fig. 1 shows a perspective view of an apparatus for projecting projectiles of a first embodiment.

Fig. 2 shows a perspective view of an apparatus for dropping a weight to treat the surface of a metal product of the second embodiment.

Fig. 3 shows a cross-sectional view of the apparatus for shot-peening of the third and fourth embodiment.

Fig. 4 shows a photomicrograph of the surface of the metal product that is treated by the method of this invention.

Fig. 5 shows a photomicrograph of the crystal grain that is fined by the method of this invention.

Preferred Embodiments of the Invention

Below, the preferred embodiments of this invention are explained.

This invention relates to a method comprising a process for forming crystal grains having sizes of less than $1\mu\text{m}$ at the surface of the metal product by projecting or peening shots or projectiles while the power per unit of area of the surface, which power is caused by projecting or peening shots or projectiles, is controlled at a predetermined value.

A steel or non-ferrous metal can be used as the material for the metal product of this invention. The surface of the metal product is defined as a portion near the surface that can be affected by projecting the shots or projectiles. The depth of the portion that is affected by projecting the shots or projectiles depends on the velocity and mass of the shots or projectiles and the period for projecting them when the surface of the metal product is projected upon by them.

It is preferable that the hardness of the shots or projectiles be equal to or higher than that of the metal product. It is also acceptable that the hardness of the shots or projectiles be lower than that of the metal product, if its surface can be hardened.

The reason the power per unit of area of the surface, which power is caused by projecting or peening shots or projectiles, is controlled at a predetermined value, is as follows:

Literature 1 says that when the surface of the metal product is projected upon by shot peening, a degree of fining the micro-structure of the surface of the metal product depends on the dislocation density and the arrangement of the dislocations, grain sizes, and phase changes of the micro-structure. However, its mechanisms are not explained in Literature 1.

In this invention, it is found that the power per unit of area of the surface, which power is caused by projecting the shots or projectiles, affects the fining of the micro-structure of the surface of the metal product.

Namely, it is possible to produce nanocrystals without repeatedly projecting the shots or projectiles, such as by the shot-peening.

"A unit of area" of the surface is defined as the sum of the contact surfaces that are projected upon by the shots or projectiles. Namely, "a unit of area" is calculated by multiplying the contact surface from a projectile or a shot by the number of the shots or projectiles, based on the assumption that the marks (surfaces contacted by the shots or projectiles) on the surface by projecting the shots or projectiles do not overlap. Thus, when the marks on

the surface do overlap, "a unit of area" is calculated by subtracting the overlapped areas calculated based on the number of shots or projectiles that have their contact surfaces overlap from the sum of the contact surfaces. Thus, basically "the unit of area" does not correspond to the surface that is treated by the shot-peening.

However, it is possible to use a surface area of the metal product treated by the shot-peening as "the unit of area," under a certain assumption.

Below, the first embodiment is explained.

Fig. 1 shows an apparatus of the first embodiment of this invention. This apparatus 10 for projecting the projectiles can project a metal ball 11 having a diameter of 4 mm on the surface of the metal product 12 through the nozzle 13 with compressed gas at a high speed. Table 1 shows the working conditions for projecting the projectiles and the results of the treatment. This treatment increases the strength of the portion of the surface since the process is instantaneously completed. Namely, nanocrystals can be formed because the small area of the surface of the metal product 12, which is projected upon by the ball 11, is quickly processed.

In comparison with the area hardened by ordinary working or made from base materials, the growth of the grain size in the area having nanocrystals is very slow. Thus, the area having nanocrystals is clearly distinguished from the other areas hardened by ordinary working or made from base materials, based on the change of the state of the micro-structure of the surface or its hardness by heating them. Since the grain size in the area hardened by working become very coarse, and the hardness of the area is reduced by heating it (the hardness of the surface is reduced from 450 Hv to 310 Hv in Vickers hardness), it is recognized that the growth of the grain sizes in the area having nanocrystals is very slow, and the decrease of the hardness of the area is little (the hardness of the area is reduced from 700 Hv to 650 Hv) by heating it.

It can be seen that an area having nanocrystals is formed, by investigating the behavior of a recrystallization.

Now, the second embodiment is explained.

Fig. 2 shows an apparatus of the second embodiment of this

invention. This apparatus 20 for dropping a weight can freely drop a weight 21 made of metal on the surface of the metal product 22 and cause a collision between the surface of the metal product 22 and the weight 21, to treat its surface. Table 1 shows the working conditions for dropping the weight and the results of the treatment. In this apparatus 20, the metal product 22 to be treated to form nanocrystals on the surface 22A is located in the bottom of the cylinder (not shown in the Figs.).

In this embodiment, the metal product 22 is already machined so that it has a final configuration and cannot move in the cylinder since the configuration of the outside of the metal product closely corresponds to that of the inside of the cylinder (not shown). The metal weight 21 is placed at the upper part in the cylinder. As explained below, a protrusion 21A is disposed at the surface of the metal weight 21, and the protrusion has a predetermined height (3 mm) from the surface of the weight 21. The protrusion 21A is disposed at the location on the weight that is opposite the point where nanocrystals should be formed on the surface 22A of the metal product 22.

The metal weight, which is placed at the upper part in the cylinder, drops freely. Consequently, the protrusion 21A of the metal weight collides with the predetermined portion of the surface 22A of the metal product 22. If the mass of the metal weight is defined as M (Kg), and the velocity of the metal weight 21 when it collides with the surface of the metal product 22 is defined as V (m/sec), then V is given as follows:

$$V = \sqrt{2gH}$$

(g: acceleration of gravity; H: distance that the weight falls)

Namely, the protrusion 21A of the metal weight 21 collides with the surface 22A of the metal product 22 at the following kinetic momentum:

$$M * \sqrt{2gH} \quad (\text{Kg} * \text{m/sec})$$

Consequently, the force, which is defined as a temporal response to the kinetic momentum, acts on the portion of the metal product 22 with which the protrusion 21A collides. Since the collision is completed in a short time, the strength of the portion of the metal product with which the protrusion collides increases significantly.

Namely, since the small area of the metal product is intensively worked in a very short time by the collision of the protrusion 21A of the metal weight 21, it is easy to form nanocrystals.

According to the result of the examination of this embodiment, the power per unit of area, that is, the power per depressed area produced by the protrusion or the contact area of it, should be at least $11 \text{ KJ/sec} \cdot \text{mm}^2$.

Namely, the accumulated kinetic momentum of the metal weight is not important, but the power per depressed area is important.

If the power per depressed area is less than $11 \text{ KJ/sec} \cdot \text{mm}^2$, no nanocrystal is formed at the surface 22A of the metal product 22. Namely, when the protrusion 21A collides with the surface 22A of the metal product 22 with a power per depressed area of more than $11 \text{ KJ/sec} \cdot \text{mm}^2$, a nanocrystal is formed at the portion with which the protrusion 21A collides.

It is preferable that the protrusion be a hemispherical protrusion that projects at a height (h) of 1–10 mm from the surface of the metal weight 21. The protrusion may have a shape of an ellipse. If a plurality of the portions on the surface of the metal product to be treated to form nanocrystals are required, the plurality of the protrusions 21A opposite the portions may be disposed at the surface of the metal weight.

The kinetic momentum explained above is defined as a function of the mass (M) of the metal weight 21 and the speed (V) of it at the moment that the protrusion collides. When the metal weight 21 having the protrusion 21A, which has a hemispherical configuration and a height of 1–10 mm, is used in the experiments of this invention, the mass (M) of the metal weight 21 is set between 0.1–10 Kg, and the speed of the weight at the moment that the protrusion collides is set at more than 1 m/sec, the power per depressed area of more than $11 \text{ KJ/sec} \cdot \text{mm}^2$ is achieved, and the nanocrystals can be formed at the surface of the metal product.

When the metal weight 21 having the plurality of the protrusions 21A is used, it is necessary to set the weight colliding with the surface 22A of the metal product 22 to the value that equals the product of the number of protrusions times the mass of the weight having a protrusion (between 0.1–10 Kg). Then, the process is completed by dropping the weight at a speed of more than 1 m/sec. Since the value of the kinetic momentum divided by the total depressed area caused by all the protrusions 21A and the deformation period satisfies the power per depressed area of more than $11 \text{ KJ/sec} \cdot \text{mm}^2$, the nanocrystals can be formed at the portions of the surface of the metal product.

Next, the third embodiment is explained.

Fig. 3 shows an apparatus of the third embodiment of this invention. This shot-peening apparatus 30 can project shots 31 having a diameter of $50\text{ }\mu\text{m}$, which shots 31 are made from steel, on the surface of the metal product 32 with compressed air through a nozzle 33. Table 1 shows the working conditions of the shot peening and the results of the treatment. From Table 1, it is found that the power per unit of area of the third embodiment to produce nanocrystals is larger than that of the first and the second embodiments.

In this embodiment, the pressure of the compressed air is controlled so that the projecting speed of the shots 31 at the metal product becomes $150\text{--}200\text{ m/sec}$. If it is required that the entire area of the surface of the metal product be treated by shot peening, it can be treated by moving the metal product 32 so that the shots are projected over the entire area. A layer constituted of a fine crystal having grain sizes of less than 100 nm is formed at the surface of the metal product 32 by means of this shot peening process. It is found that the hardness of the layer having the fine crystal is significantly increased. Fig. 4 shows a photomicrograph of the surface of the metal product that is treated by the method of the third embodiment of this invention. Fig. 5 also shows a photomicrograph of the crystal grain that is fined by the method of the third embodiment of this invention.

As explained above, since the layer constituted of a fine crystal can be formed at the surface of the metal product 32 by using the method of the third embodiment of this invention, its hardness significantly increases. Thus, the strength of the metal product 32 also increases, and the fatigue strength and corrosion resistance of the metal product can be improved.

Now, the fourth embodiment is explained.

Fig. 3 shows an apparatus of the fourth embodiment of this invention, which figure is the same figure as that shown for the third embodiment. This shot-peening apparatus 30 can project shots 31 having a diameter of $50\text{--}300\text{ }\mu\text{m}$ and made from stainless steel on the surface of the metal product 32 with compressed air through a nozzle 33. Table 1 shows the working conditions of the shot peening and the results of the treatment. From Table 1, it is found that the power per unit of area of this embodiment to produce nanocrystals is larger than that of the first and the second

embodiments.

In this embodiment, the pressure of the compressed air is controlled so that the projecting speed of the shots 31 on the metal product becomes 80 m/sec. If it is required that the entire area of the surface of the metal product be treated by the shot peening, it can be treated by moving the metal product 32 so that the shots are projected at the entire area. As well as in the third embodiment, a layer constituted of a fine crystal having grain sizes of less than 100 nm is formed at the surface of the metal product 32 by means of this shot peening process. It is found that the hardness of the layer having the fine crystal is significantly increased. Shots made not only from stainless steel, but also from high-carbon steel or ferrous metallic glass, can be used. Further, shots having a range of diameters of 30 μm to 2000 μm can be used.

As explained above, since a layer constituted of a fine crystal can be formed at the surface of the metal product 32 by using the method of the fourth embodiment of this invention, its hardness significantly increases. Thus, as well as in the third embodiment, the strength of the metal product 32 also increases, and the fatigue strength and corrosion resistance of the metal product can be improved.

Generally, when a surface of a metal product is treated by shot peening, a work hardening is caused at the surface. It is well known that the degree of the work hardening of the metal is proportional to the square root of its dislocation density. When the process for working the metal product is continued, since the speed of the disappearance of its dislocations caused by a merger between the dislocations of grains increases, the rate of the work hardening decreases gradually as the degree of working increases. However, when the metal product is worked hard at a high strain rate, since no disappearance of the dislocations of grains is caused, the dislocation density of the grains increases. Then, when the dislocation density reaches a critical value, a dislocation-cell structure changes to a grain-boundary structure.

Further, the fining of the micro-structure of the surface of the metal product is improved by projecting the projectiles or the shots to the surface while the temperature of the metal surface is controlled to be between room temperature and $-150\text{ }^{\circ}\text{C}$. It is difficult for the number of the dislocations of the grains to reach the critical dislocation density. This allows the grains

to be recrystallized, since the recovery rate of the dislocations of the grains increases with the increased temperature of the surface due to the continuous projection of the projectiles or the shots. However, in the condition at low temperature, since the recovery rate of the grain structure which is fined by projecting the projectiles or the shots decreases, it becomes easy for the number of the dislocations of the grain to increase. Namely, it becomes easy for the dislocation density to reach the critical value, which value allows the grain to be fined.

In this embodiment, liquid nitrogen (temperature: -196°C) and liquid carbon dioxide (temperature: -79°C) can be used to cool the metal product. It is preferable to control the temperature of the metal product to be between room temperature and about -150°C based on the material of the product. It is possible to form finer grains by using this method compared to the method for projecting the projectiles or the shots at room temperature.

Industrial Applicability

This invention relates to a method for fining a surface of a metal product to form crystal grains having sizes less than $1\mu\text{m}$ at its surface and to produce the metal product by the method. By this method, since the fatigue strength, the hardness, and the corrosion resistance of the metal product can be improved, the method possesses a possibility of industrial applicability.